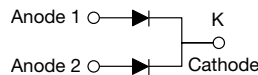
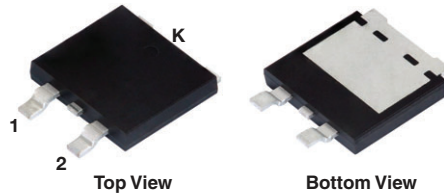


Ultrafast Rectifier, 2 x 8 A FRED Pt®

eSMP® Series SMPD (TO-263AC)



FEATURES

- Ultrafast recovery time, reduced Q_{rr} , and soft recovery
- 175 °C maximum operating junction temperature
- For PFC CRM, snubber operation
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | |
|-------------------------|-----------------|
| $I_{F(AV)}$ | 2 x 8 A |
| V_R | 600 V |
| V_F at I_F | 0.94 V |
| t_{rr} | 45 ns |
| T_J max. | 175 °C |
| Package | SMPD (TO-263AC) |
| Circuit configuration | Common cathode |

DESCRIPTION / APPLICATIONS

State of the art ultrafast recovery rectifiers specifically designed with optimized performance of forward voltage drop, ultrafast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in PFC, boost, in the AC/DC section of SMPS, freewheeling and clamp diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element and snubbers.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating
Halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per J-STD-002

| ABSOLUTE MAXIMUM RATINGS | | | | |
|-----------------------------------|-------------|--|--------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Peak repetitive reverse voltage | V_{RRM} | | 600 | V |
| Average rectified forward current | $I_{F(AV)}$ | $T_{solder\ pad} = 149\ ^\circ C$ | 16 | A |
| per device | | | 8 | |
| Non-repetitive peak surge current | I_{FSM} | $T_J = 25\ ^\circ C, 6\ ms\ square\ pulse$ | 200 | |
| per diode | | | 105 | |

| ELECTRICAL SPECIFICATIONS ($T_J = 25\ ^\circ C$ unless otherwise specified) | | | | | | |
|--|---------------|---|------|------|------|---------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage | V_{BR}, V_R | $I_R = 100\ \mu A$ | 600 | - | - | V |
| Forward voltage, per diode | V_F | $I_F = 8\ A$ | - | 1.1 | 1.4 | |
| | | $I_F = 8\ A, T_J = 150\ ^\circ C$ | - | 0.94 | 1.15 | |
| Reverse leakage current, per diode | I_R | $V_R = V_R\ rated$ | - | - | 5 | μA |
| | | $T_J = 150\ ^\circ C, V_R = V_R\ rated$ | - | 20 | 150 | |
| Junction capacitance, per diode | C_T | $V_R = 600\ V$ | - | 8 | - | pF |



| DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified) | | | | | | |
|--|-----------|--|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time | t_{rr} | $I_F = 1\text{ A}$, $di_F/dt = 50\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$ | - | 45 | - | ns |
| | | $I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $I_{rr} = 0.25\text{ A}$ | - | - | 60 | |
| | | $T_J = 25\text{ }^\circ\text{C}$ | - | 70 | - | |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 100 | - | |
| Peak recovery current | I_{RRM} | $T_J = 25\text{ }^\circ\text{C}$ | - | 12 | - | A |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 17 | - | |
| Reverse recovery charge | Q_{rr} | $T_J = 25\text{ }^\circ\text{C}$ | - | 430 | - | nC |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 850 | - | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|---|----------------|----------------------------|---------|------|------|---------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Maximum junction and storage temperature range | T_J, T_{Stg} | | -55 | - | +175 | $^\circ\text{C}$ |
| Thermal resistance, per diode junction to mount | R_{thJM} | | - | 1.8 | 2.5 | $^\circ\text{C}/\text{W}$ |
| Approximate weight | | | 0.55 | | | g |
| | | | 0.02 | | | oz. |
| Marking device | | Case style SMPD (TO-263AC) | 16CDU06 | | | |

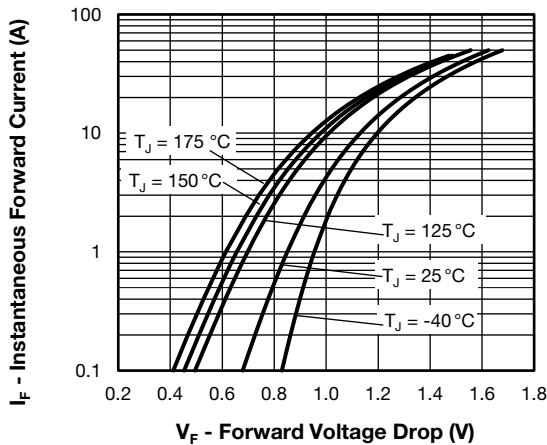


Fig. 1 - Typical Forward Voltage Drop Characteristics

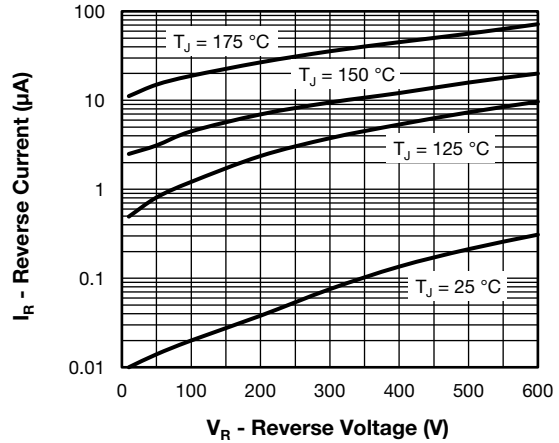


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

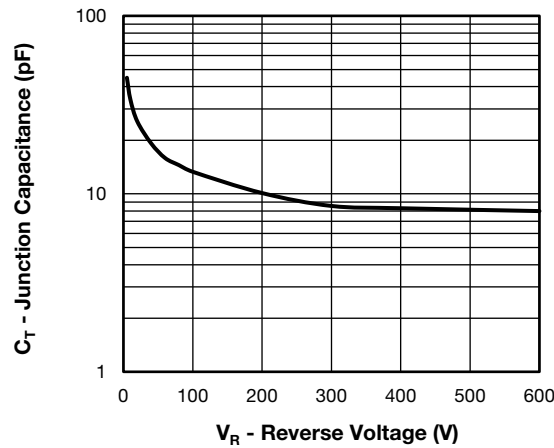


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

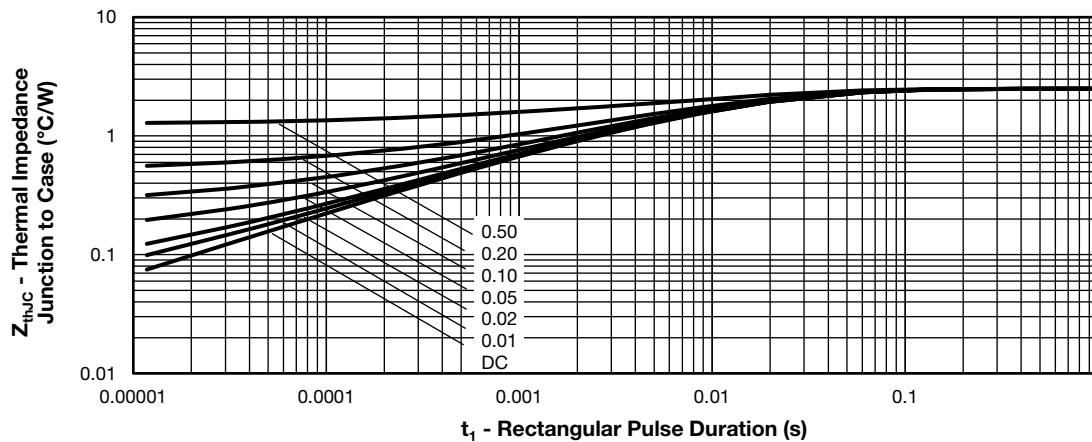


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

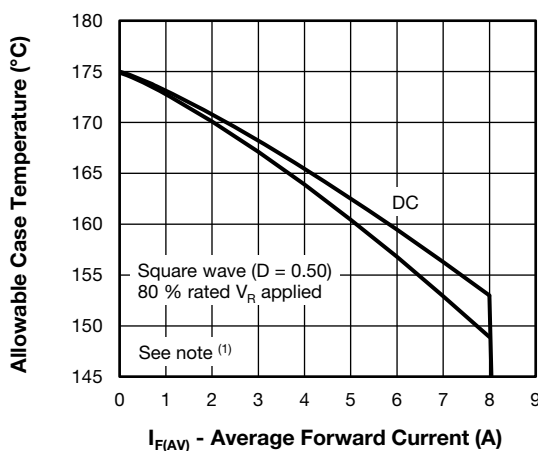


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

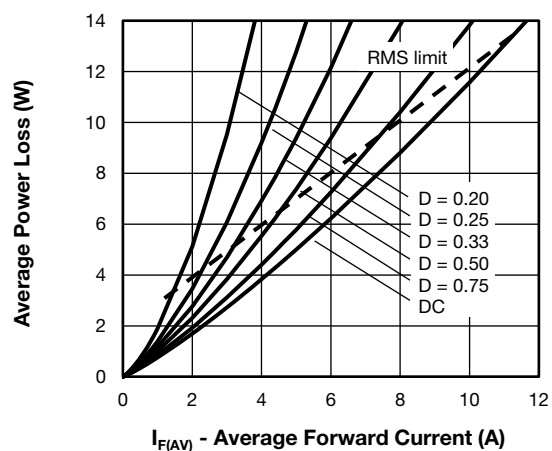


Fig. 6 - Forward Power Loss Characteristics

Note

- (1) Formula used: $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$;
 P_d = forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 5);
 P_{dREV} = inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = rated V_R

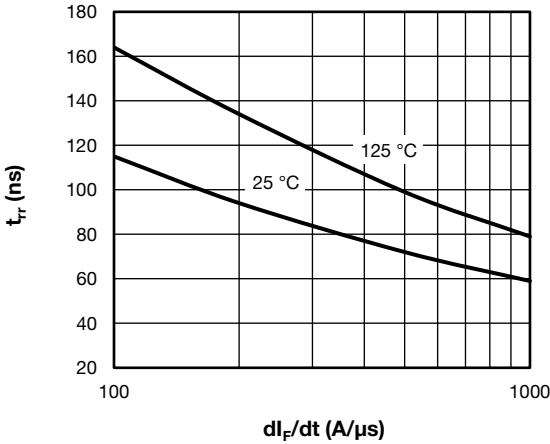


Fig. 7 - Typical Reverse Recovery Time vs. di_F/dt

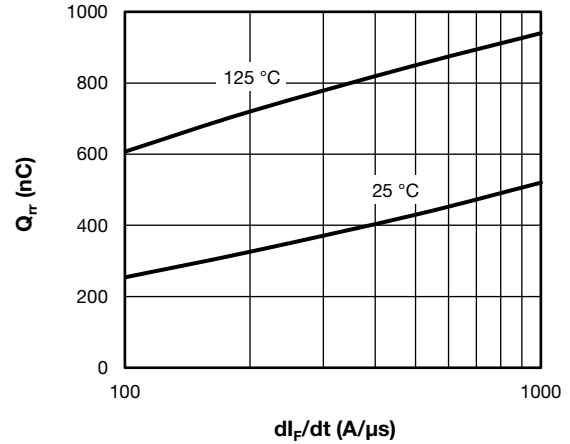
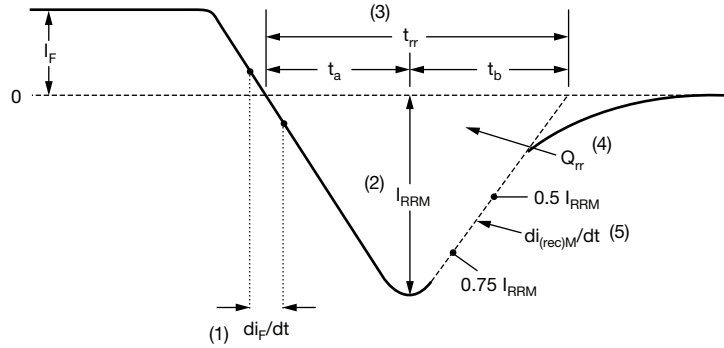


Fig. 8 - Typical Stored Charge vs. di_F/dt



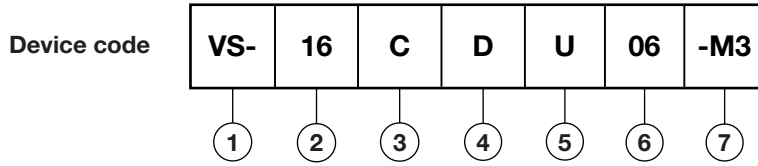
- (1) di_F/dt - rate of change of current through zero crossing
- (2) I_{RRM} - peak reverse recovery current
- (3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through $0.75 I_{RRM}$ and $0.50 I_{RRM}$ extrapolated to zero current.
- (4) Q_{rr} - area under curve defined by t_{rr} and I_{RRM}
- (5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

Fig. 9 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Current rating (16 A)
- 3** - Circuit configuration:
C = common cathode
- 4** - D = SMPD package
- 5** - Process type,
U = ultrafast recovery
- 6** - Voltage code (06 = 600 V)
- 7** - -M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

| ORDERING INFORMATION (Example) | | | |
|---------------------------------------|--------------------------|-------------------------------|------------------------------------|
| PREFERRED P/N | QUANTITY PER REEL | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION |
| VS-16CDU06-M3/I | 2000 | 2000 | 13" diameter plastic tape and reel |

| LINKS TO RELATED DOCUMENTS | |
|-----------------------------------|--|
| Dimensions | www.vishay.com/doc?95604 |
| Part marking information | www.vishay.com/doc?95566 |
| Packaging information | www.vishay.com/doc?88869 |
| SPICE model | www.vishay.com/doc?96575 |



TO-263AC (SMPD)

DIMENSIONS in inches (millimeters)





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